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STW26NM50

N-channel 500 V, 0.10 Ω, 30 A TO-247 MDmesh™ Power MOSFET

Features

Туре	V _{DSS}	R _{DS(on)} max	Ι _D
STW26NM50	500 V	< 0.12 Ω	30 A

- High dv/dt and avalanche capabilities
- Improved ESD capability
- Low input capacitance and gate charge

Application

Switching applications

Description

MDmesh[™] technology applies the benefits of the multiple drain process to STMicroelectronics' well-known PowerMESH[™] horizontal layout structure. The resulting product offers low onresistance, high dv/dt capability and excellent avalanche characteristics.

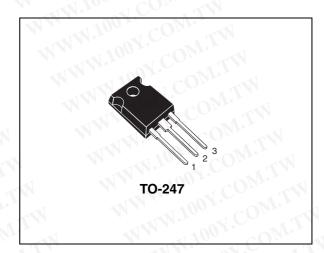
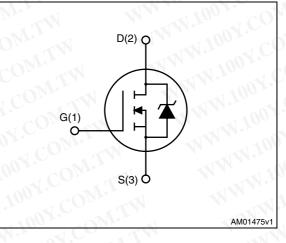


Figure 1. Internal schematic diagram



Order codes	Marking	Package	Packaging	-1
STW26NM50	W26NM50	TO-247	Tube	

COM Contents

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2	Electrical characteristics
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Electrical ratings

Table 2.	Absolute maximum ratings	LCON TW	
Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	500	V
V _{GS}	Gate-source voltage	±30	V
I _D	Drain current (continuous) at $T_C = 25 \text{ °C}$	30	А
ID	Drain current (continuous) at $T_C = 100 \ ^{\circ}C$	18.9	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	120	Α
P _{TOT}	Total dissipation at $T_{C} = 25 \text{ °C}$	313	W
No.	Derating factor	2.5	W/°C
V _{ESD(G-S)}	Gate source ESD (HBM-C=100 pF, R=1.5 kΩ)	6000	V
dv/dt ⁽²⁾	Peak diode recovery voltage slope	15	V/ns
T _{stg}	Storage temperature	-55 to 150	°C
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Table 3.	Thermal data	WWW.IC	JU ×
Symbol	Parameter	Value	Un
R _{thj-case}	Thermal resistance junction-case max	0.4	°C
R _{thj-amb}	Thermal resistance junction-ambient max	62.5	°C/
CDM	Maximum lead temperature for soldering purpose	300	°C

Table 4.

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Symbol	Parameter	Value	Uni
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by $T_{j max}$)	13	Α
E _{AS}	Single pulse avalanche energy (starting T_J =25 °C, I_D = I_{AR} , V_{DD} =50 V)	740	mJ

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Electrical characteristics WW.100Y.COM.TW

N.100X.COM.TW (T_{CASE} = 25 °C unless otherwise specified)

Table 5.	On/off states	N. IV. IV. CO.				
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0$	500	TW	1	v
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max rating V_{DS} = Max rating, T _C =125 °C	1.00	MT	10 100	μΑ μΑ
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	$V_{GS} = \pm 20 V$	N.C	-01/ 01/2-	± 10	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10 V, I _D = 13 A	100	0.10	0.12	Ω

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Table 5 **On/off states**

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Symbol	Parameter	Test conditions	Min.	Тур.	Max.
9 _{fs} ⁽¹⁾	Forward transconductance	V _{DS} =15 V, I _D =13 A	-	20	
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer Capacitance	V _{DS} = 25 V, f = 1 MHz, V _{GS} = 0	44	3000 700 50	1005
C _{oss eq.} (2	Equivalent output capacitance	$V_{GS} = 0, V_{DS} = 0$ to 400 V	-	300	N ⁱ .V
Q _g Q _{gs} Q _{qd}	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 400 \text{ V}, I_D = 26 \text{ A},$ $V_{GS} = 10 \text{ V},$ <i>(see Figure 15)</i>	-	76 20 36	NNN NNN

WWW.100Y.CON WWW.2. $C_{oss~eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DS}

Table 7.	Switching times
ladie 7.	Switching times

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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 250 V, I _D = 13 A,		28		ns
tr	Rise time	$R_{G} = 4.7 \ \Omega, V_{GS} = 10 \ V,$	COM-	15		ns
t _{d(off)}	Turn-off-delay time	(see Figure 15)		13	N	ns
t _f	Fall time			19		ns

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Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD} I _{SDM} ⁽¹⁾	Source-drain current Source-drain current (pulsed)	WWW.100X.COM	TN		26 104	A A
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 26 \text{ A}, V_{GS} = 0$	1.5		1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _{SD} = 26 A, di/dt = 100 A/μs V _{DD} = 100 V (<i>see Figure 16</i>)	N. N.	400 5.5 27.8	J	ns μC Α
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 26 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$ $V_{DD} = 100 \text{ V, T}_{j} = 150 \text{ °C}$ (see Figure 16)	. <u>.</u>	492 7 28.8	W.	ns μC Α

Table 8. Source drain diode

Pulse width limited by safe operating area 1.

Pulsed: pulse duration = 300 µs, duty cycle 1.5% 2.

Tab	ble	9	
IUN		<u>v</u> .	

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Gate-source Zener diode

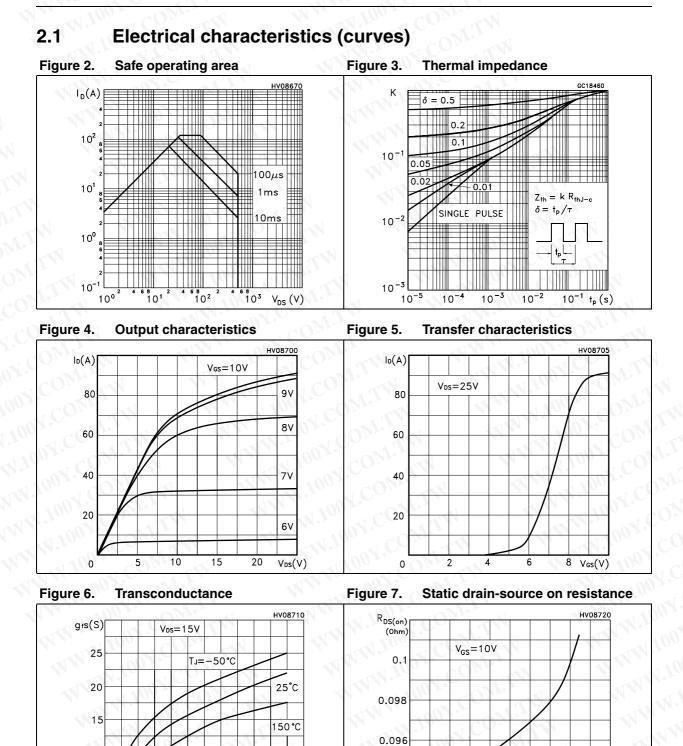
Table 9.	Gate-source Zener diode					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
BV _{GSO}	Gate-source breakdown voltage	Igs=± 1 mA (open drain)	30	1001		v

The built-in back-to-back Zener diodes have specifically been designed to enhance not only the device's ESD capability, but also to make them safely absorb possible voltage transients that may occasionally be applied from gate to source. In this respect the Zener voltage is appropriate to achieve an efficient and cost-effective intervention to protect the device's integrity. These integrated Zener diodes thus avoid the usage of external components.

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 $I_D(A)$

20

10

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0

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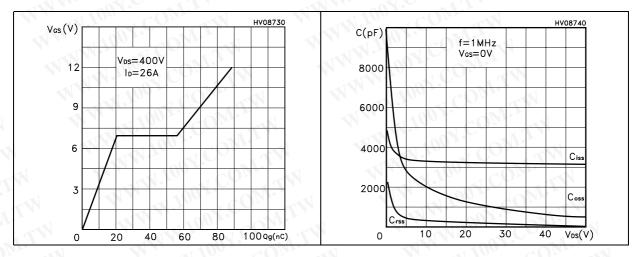
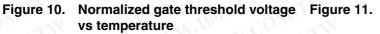
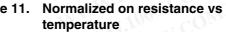
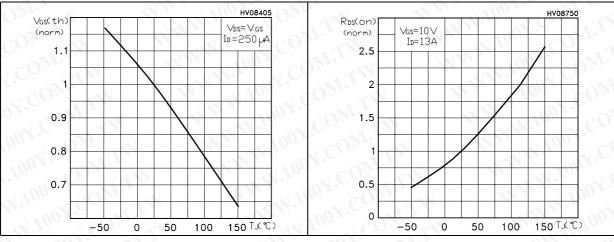


Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations







HV08760

25°C

150°C

25 ISD(A)

TJ=-50℃

Figure 12. Source-drain diode forward characteristics

Vsd(V)

0.9

0.8

0.7

0.6

0.5

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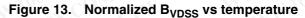
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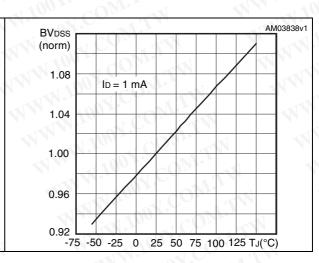
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3 Test circuits

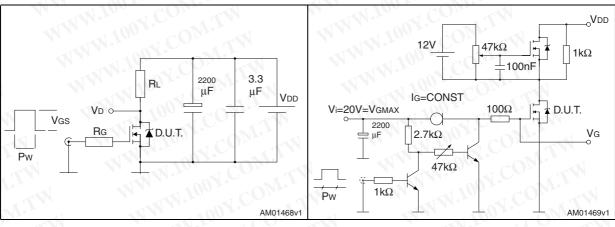
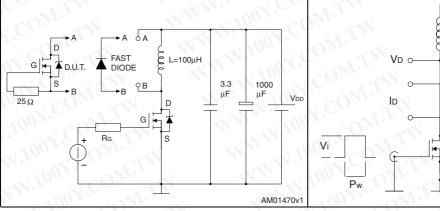


Figure 14. Switching times test circuit for Figure 15. Gate charge test circuit resistive load





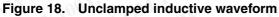


Figure 19. Switching time waveform

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2200

μF

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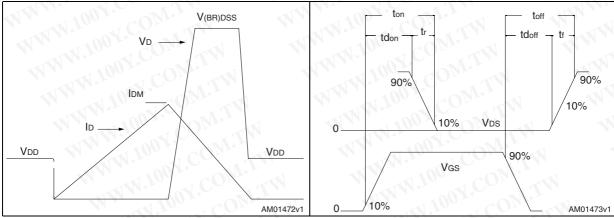
3.3

μF

VDD

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Package mechanical data

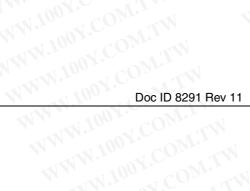
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

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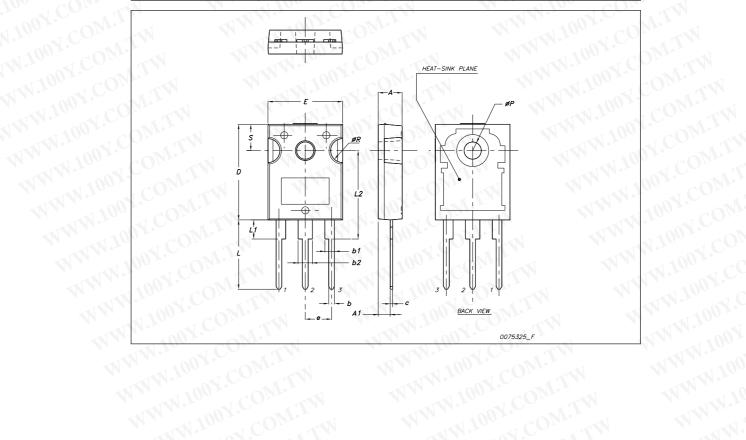
Package mechanical data WWW.IOU

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WW NO0	E COMPANY		1.100 mm. 011	
WWW.	Dim.	Min.	Тур.	Max.
N. N. N.	A	4.85	W.P. S.Cor	5.15
	A1	2.20	N.100 CON	2.60
NN	b	1.0	1001.	1.40
VAN	b1	2.0	WW. ON.	2.40
	b2	3.0	N. IV. IV	3.40
AL.	c	0.40	WW 1001.	0.80
	D	19.85	1001	20.15
	E.	15.45	N.W.	15.75
V V	e	COMM	5.45	CONTRA
	NNL 100	14.20	ANN 10	14.80
L.	L1	3.70	ALW	4.30
WT.	L2	N.CON TW	18.50	COpre
1	øP	3.55		3.65
M.I.	øR	4.50		5.50
	S		5.50	N.M. N.CO

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Revision history

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WWW.100Y.COM Table 10.

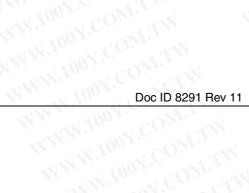
Date	ument revisio Revision	Changes
4-Jun-2004	9	New stylesheet.
7-Feb-2005	10	I _D value changed
2-Oct-2009	11	Modified: test condition of V _{(BR)DSS} in <i>Table 5</i>

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